

C0402C271K2TACTU

Aliases (C0402C271K2TAC7867) SMD Comm X8G HT150C, Ceramic, 270 pF, 10%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



Click here for the 3D model.

| General Information | |
|--------------------------|--|
| Series | SMD Comm X8G HT150C |
| Style | SMD Chip |
| Description | SMD, MLCC, High Temperature, Ultra-Stable |
| Features | High Temperature, Ultra-Stable |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 1.06 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Dimensions | | |
|------------|-----------------|--|
| Chip Size | 0402 | |
| L | 1mm +/-0.05mm | |
| W | 0.5mm +/-0.05mm | |
| т | 0.5mm +/-0.05mm | |
| S | 0.3mm MIN | |
| В | 0.3mm +/-0.1mm | |
| | | |

Packaging Specifications

| Packaging Quantity 10000 | |
|--------------------------|--|

| Specifications | |
|--|--|
| Capacitance | 270 pF |
| Measurement Condition | 1 MHz 1.0Vrms |
| Tolerance | 10% |
| Voltage DC | 200 VDC |
| Dielectric Withstanding Voltage | 500 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 100 GOhms |

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